
 SMT SOLDER AREA

 THIS AREA SHOULD BE FREE OF ANY CONDUCTIVE TRACES

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ± 0.05

NOTES:

- MATERIAL:
HOUSING: LCP, BLACK, UL 94V-0
CONTACT: PHOSPHOR BRONZE, T=0.10MM
SHELL: STAINLESS STEEL T=0.10MM
- FINISH:
CONTACT: NI 50u"min PLATING OVER ALL,
Au 3u"min PLATING ON THE CONTACT AREA AND SOLDER AREA
SHELL: SELECTIVE GOLD FLASH IN SOLDER TAIL AREA
NI 50u"min PLATING OVER ALL
- GP PASSED ACCORD WITH RoHS STANDARD.
- ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC.
- ALL DIMENSIONS MARKED (XX) MUST BE CONTROLLED BY QC.

PIIN/NO.	ASSIGNMENT
C1	Vcc(SUPPLY VOLTAGE)
C2	RST(RESET SIGNAL)
C3	CLK (CLOCK SIGNAL)
CD	DETECT SEITCH
C6	Vpp (VARIABLE SUPPLY BOLTAGE)
C5	GND
C7	I/O (DATA INPUT/OUTPUT)

REV.	ECN NO.	DESCRIPTION	DATE	UNITS: mm	GENERAL TOLERANCE	DRAW:	PART NO:
				DATE: 08/19/2017	X. ±0.20 .X ±0.15 .XX ±0.10 .XXX ±0.05	CHECKED:	S182-0B07F15A
				SCALE: 8/1	X.' ±2.00 .X' ±1.00 .XX' ±0.50 .XXX' ±0.10	APPROVE:	TITLE: 1.35H NANO SIM CARD CONN.
A		NEW	04/06/2017	SHEET: 1/2	MATERIAL:		DRAWING NO:
				REV. A	FINISH: SEE NOTE		



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